ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES INTERNATION CONNECTING	C, Bannockl	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar he declaration	ation of the encompas	substance ses all low	s within the er level mat	manufacture erials for wh	er listed ite	m. Note nufactu	: if the item is an rer has engineerin	assembly with low ng responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form 7 http://www.ipc.org/IPC-175x Distrib				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information			
Supplier Information														
Company name*	Company un	Company unique ID			Unique ID Authority					Response Date*				
nsemi									2024-05-11					
Description of the second seco			ct				Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			sentative	ative Ph		Phone - Rep	Phone - Representative*			Email - Representative*				
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	r Mfr Item N		Number Mfr Item Name			Effective Da	te Versio	on	Manufacturing Site		W	eight*	UOM	Unit Type
	NRVTS GA01	NRVTSA4100ET3G- GA01 4A, 100V Low Le RECTIFIER		eakage TRENC	NCH 2024-0				CNP		6.	3.0	mg	Each
Aanufacturing Proccess Informat	ion													
Terminal Plating / Grid Array Ma	inal Plating / Grid Array Material Terminal Base All		Alloy	J-STD-020 MSI	L Rating	Peak Pr	ocess Body	Temperat	ure Max Ti	me at Peak '	Temperatu	re Nur	mber of Reflow C	Cycles
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30		second	s 3			
omments														
vel 1 - maximum time at peak temperatu	re during so	Idering is 10-3	0 seconds											
or more information regarding material (composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	6.3	mg	Supplier	Iron (Fe)	7439-89-6		0.0063	mg
			Supplier	Copper (Cu)	7440-50-8		6.2918	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0019	mg
Die	1.43	mg	Supplier	Silicon (Si)	7440-21-3		1.43	mg
Die Attach Solder	2.2	mg	Supplier	Silver (Ag)	7440-22-4		0.055	mg
			А	Lead (Pb)	7439-92-1	7a	2.035	mg
			Supplier	Tin (Sn)	7440-31-5		0.11	mg
Lead Frame	22.69	mg	Supplier	Iron (Fe)	7439-89-6		0.0227	mg
			Supplier	Copper (Cu)	7440-50-8		22.6605	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0068	mg
Mold Compound-Black	30.28	mg	Supplier	Polycondensate of 4,4'- bis(methoxymethyl)biphenyl and phenol	205830-20-2		0.757	mg
			Supplier	Triphenylphosphine	603-35-0		0.1514	mg
			Supplier	Trimethoxysilylpropanethiol	4420-74-0		0.1514	mg
			Supplier	4,4'-Bis(2,3-epoxypropoxy)-3,3',5,5'- tetramethylbiphenyl	85954-11-6		0.1514	mg
			Supplier	Carbon Black (C)	1333-86-4		0.3028	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		27.252	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.514	mg
Plating	0.1	mg	Supplier	Tin (Sn)	7440-31-5		0.1	mg